

MM908E622ACPEK Information


For Reference Only

Part Number [MM908E622ACPEK](#)
Manufacturer NXP
Category Integrated Circuits (ICs)
[Embedded - Microcontrollers - Application Specific](#)
Description IC QUAD HALF BRDG TRPL SW 54SOIC
Package 54-BSSOP (0.295", 7.50mm Width) Exposed Pad
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


MM908E622ACPEK Specifications

Manufacturer Part Number	MM908E622ACPEK
Manufacturer	NXP
Category	Integrated Circuits (ICs) Embedded - Microcontrollers - Application Specific
Package	54-BSSOP (0.295", 7.50mm Width) Exposed Pad
Series	-
Applications	Automotive Mirror Control
Core Processor	HC08
Program Memory Type	FLASH (16 kB)
Controller Series	908E
RAM Size	512 x 8
Interface	SCI, SPI
Number of I/O	12
Voltage - Supply	9 V ~ 16 V
Operating Temperature	-40°C ~ 85°C
Mounting Type	Surface Mount
Package / Case	54-BSSOP (0.295", 7.50mm Width) Exposed Pad
Supplier Device Package	54-SOICW-EP

[Report errors?](#)

MM908E622ACPEK Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MM908E622ACPEK Payment Methods



MM908E622ACPEK Shipping Methods



If you have any question about MM908E622ACPEK, please do not hesitate to contact us!

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